



Journal of *Manufacturing and Materials Processing*

Dear Colleagues,

As Editor-in-Chief of *JMMP* (*Journal of Manufacturing and Materials Processing*), I am pleased to announce the winner of the 2019 Travel Award sponsored by *JMMP*. The award was granted to **Dr. Pan Wang**, postdoctoral fellow of the Singapore Institute of Manufacturing Technology (SIMTech). He will receive **800 Swiss Francs** for travel expenses to attend the 10th Pacific Rim International Conference on Advance Materials and Processing (PRICM-10) to be held in Xi'an, China.

Dr. Pan Wang's current research is focused on additive manufacturing of metal and polymers, high-quality powder for additive manufacturing, phase transformation and deformation behavior of metastable alloys, and superplastic deformation of Mg and Al alloys.

2019 TRAVEL AWARD WINNER

JMMP is proud to support this young researcher working in the fields of processes, equipment, systems, and materials in relation to manufacturing, and wish him further success in his career. We are grateful to all who submitted applications—thank you for letting us get to know you and your work. We hope all of you will continue following *JMMP* in the future.

I personally would like to congratulate the winner and thank the selection committee for their excellent work in choosing the winner from such a large number of excellent candidates.

Prof. Dr. Steven Y. Liang
JMMP Editorial Office
Editor-in-Chief



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